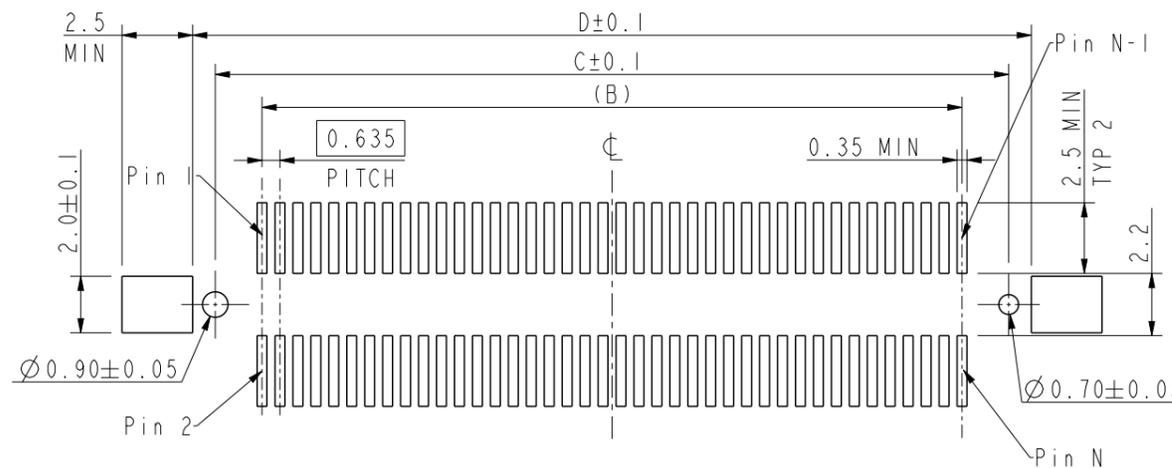
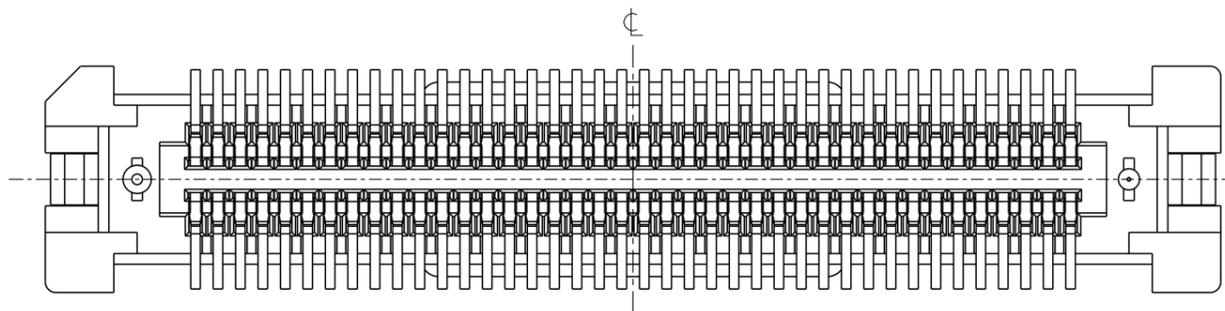
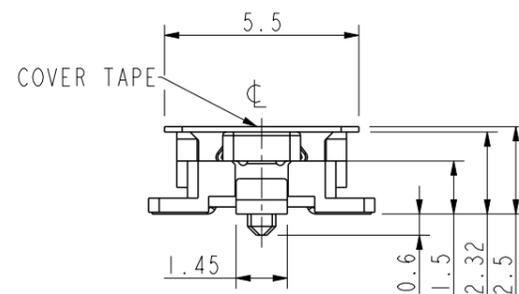
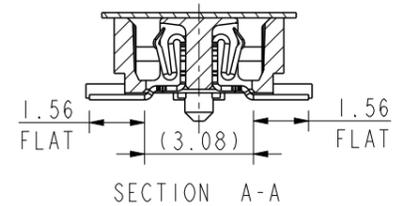
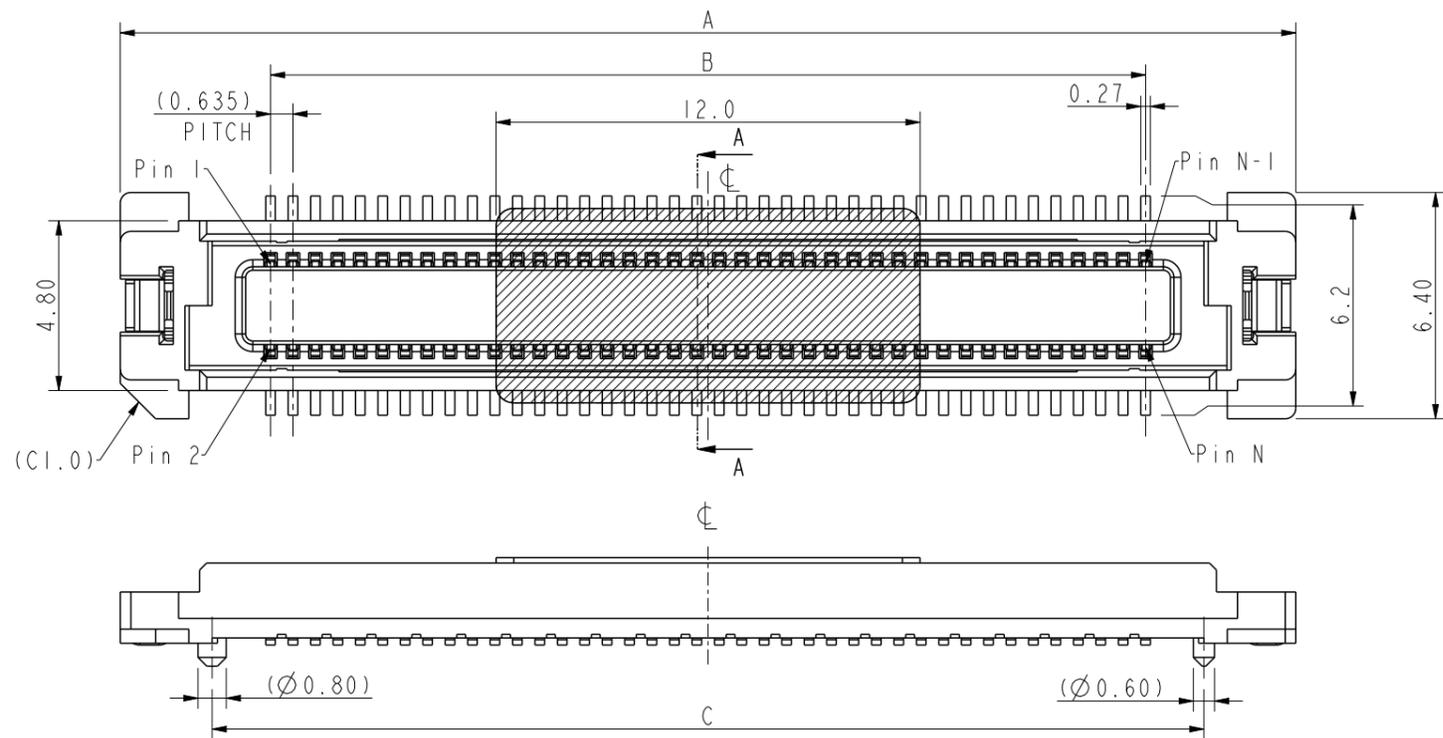


Part Number	POS	DIM "A"	DIM "B"	DIM "C"	DIM "D"
10169698-40000RLF	80	33.27	24.765	28.07	29.67
10169698-70000RLF	140	52.32	43.815	47.12	48.72



- NOTES:
- MATERIAL:
 - HOUSING: LCP, WHITE, UL94V-0
 - TERMINAL AND HOLD DOWN: COPPER ALLOY.
 - VACUUM TAPE: POLYIMIDE (PI)
 - PLATING:
 - 1.5µm MIN NI UNDER PLATING;
 - 0.05µm MIN AU ON SOLDER AREA;
 - 0.10µm MIN AU ON MATING AREA.
 - PRODUCTION SPECIFICATION GS-12-1709;
 - THIS HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 20 SECONDS IN A IR REFLOW SOLDERING APPLICATION;
 - THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008;
 - COPLANARITY AREA OF TERMINATION 0.1MM MAX.

spec ref	dr	Hao-Liang Sun	2022/11/03	projection	mm	size	A3	scale	5:1
tolerance std	eng	-	2022/11/03			ecn no	-	rel level	Preliminary
TOLERANCES UNLESS OTHERWISE SPECIFIED									
surface	linear	0.X	±0.25	Amphenol FCI RECEPTACLE CONN 0.635 MM PITCH BTB	dwg no 10169698	rev 1			
		0.XX	±0.15						
	0.XXX	±0.05							
angular	0°	±2°	amphenol-icc.com	cat. no.	Product - Customer Drw	sheet 1 of 1			